Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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BIPOLAR ANALOG INTEGRATED CIRCUIT

 μ PC1663

DC to VHF WIDEBAND DIFFERENTIAL INPUT AND OUTPUT AMPLIFIER IC

DESCRIPTION

The μ PC1663 is a differential input, differential output wideband amplifier IC that uses an high frequency silicon bipolar process. This process improves bandwidth phase characteristics, input noise voltage characteristics, and low power consumption when compared to conventional HF-band differential amplifier ICs.

These features make this device suitable as a wideband amplifier in high-definition TVs, high-resolution monitors, broadcasting satellite receivers, and video cameras, as a sense amplifier in high-density CCD and optical pick-up products, or as a pulse amplifier for optical data links.

These ICs are manufactured using NEC's 6 GHz fr NESATTM I silicon bipolar process. This process uses silicon nitride passivation film and gold electrodes. These materials can protect chip surface from external pollution and prevent corrosion/migration. Thus, these ICs have excellent performance, uniformity and reliability.

FEATURES

• Bandwidth and typical gain: 120 MHz @ AvoL = 300

700 MHz @ AvoL = 10

• Phase delay : -85 deg. @ AvoL = 100, 100 MHz • Input Noise Voltage : $3 \mu V_{r.m.s.}$ (Rs = 50Ω , 10 k to 10 MHz)

Supply Current : 13mA TYP. @ Vcc[±] = ±6 V
 Gain adjustable from 10 to 300 with external resistor

No frequency compensation required (Small phase delay at 10 MHz or less)

ORDERING INFORMATION

Part Number	Package	Marking	Supplying Form
μPC1663G-E1	8-pin plastic SOP (225 mil)	1663	Embossed tape 12 mm wide. Pin 1 is in tape pull-out direction. Qty 2.5 kp/reel.
μPC1663GV-E1	8-pin plastic SSOP (175 mil)		Embossed tape 8 mm wide. Pin 1 is in tape pull-out direction. Qty 1 kp/reel.

Remark To order evaluation samples, please contact your local NEC sales office. (Part number for sample order: μ PC1663GV)

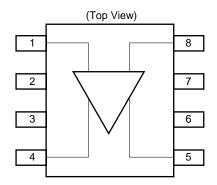
Caution μ PC1663C (8-pin plastic DIP) is discontinued.

Caution Electro-static sensitive devices

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CONNECTION DIAGRAM



Pin No.	Pin Name	
1	IN ₂	
2	G _{1B}	
3	Vcc ⁻	
4	OUT ₂	
5	OUT ₁	
6	Vcc⁺	
7	G _{1A}	
8	IN ₁	

PIN EXPLANATIONS

Pin No.	Pin Name	In Dual Bias (V)	In Single Bias (V)	Functions and Applications	Internal Equivalent Circuit
8	IN ₁	Pin voltage 0	Apply voltage Vcc/2	Input pin	6
5 4	OUT ₁	Pin voltage 0	Apply voltage Vcc/2	Output pin	
6	Vcc⁺	±2 to ±6.5	-0.3 to +14	Plus voltage supply pin. This pin should be connected with bypass capacitor to minimize AC impedance.	8 7 2 1
3	Vcc ⁻		GND	Minus voltage supply pin. This pin should be connected with bypass capacitor to minimize AC impedance.	3
7 2	G1A G1B	_	_	Gain adjustment pin. External resistor from 0 to 10 $k\Omega$ can be inserted between pin 2 and 7 to determine gain value.	Internal circuit constants should be referred to application note.

Note $\ \mu PC$ 1664 which had G_{2A}, G_{2B} of the other gain adjustment pins is discontinued.



ABSOLUTE MAXIMUM RATINGS ($T_A = +25$ °C)

Parameter	Symbol	μPC1663G	μPC1663GV	Unit
Supply Voltage	Vcc [±]	±7	±7	V
Power Dissipation	Po	280 (T _A = +75°C) ^{Note}	280 (T _A = +75 °C) ^{Note}	mW
Differential Input Voltage	VID	±5	±5	V
Input Voltage	Vісм	±6 (within Vcc ⁻ to Vcc ⁺ range)	±6 (within Vcc ⁻ to Vcc ⁺ range)	V
Output Current	lo	35	35	mA
Operating Ambient Temperature	TA	-45 to +75	-45 to +75	°C
Storage Temperature	Tstg	-55 to +150	-55 to +150	°C

 $\textbf{Note} \quad \text{Mounted on double sided copper clad } 50 \times 50 \times 1.6 \text{ mm epoxy glass PWB}$

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc [±]	±2	±6	±6.5	V
Output Source Current	O source	_	_	20	mA
Output Sink Current	IO sink	_	_	2.5	mA
Operating Frequency Range	f _{opt}	DC	_	200	MHz

3



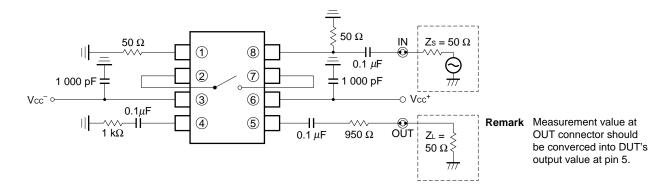
ELECTRICAL CHARACTERISTICS (TA = +25 °C, Vcc[±] = ±6 V)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Differential Voltage Gain	Gain 1	Avd	f = 10 MHz ^{Note 1}	200	320	500	_
	Gain 2		f = 10 MHz ^{Note 2}	8	10	12	
Bandwidth	Gain 1	BW	Rs = 50Ω (3 dB down point)	_	120	_	MHz
	Gain 2			_	700	_	
Rise Time	Gain 1	tr	Rs = 50 Ω, Vout = 1 VP-P		2.9		ns
	Gain 2			_	2.7	_	
Propagation Delay	Gain 1	t pd	Rs = 50 Ω, Vout = 1 VP-P		2		ns
	Gain 2			_	1.2	_	
Input Resistance	Gain 1	Rin		_	4.0	_	kΩ
	Gain 2			50	180		
Input Capacitance		Cin			2		pF
Input Offset Current		lio		_	0.4	5.0	μΑ
Input Bias Current		lв		_	20	40	μΑ
Input Noise Voltage		Vn	Rs = 50Ω , $10 k to 10 MHz$	_	3	_	μV r.m.s.
Input Voltage Range		Vı		±1.0	ı	_	V
Common Mode Rejection Ratio	Gain 2	CMR	$V_{cm} = \pm 1 \text{ V, f} \le 100 \text{ kHz}$	53	94	_	dB
Supply Voltage Rejection F	Ratio	SVR	$\Delta V = \pm 0.5 \text{ V}$	50	70	_	dB
Output Offset Voltage	Gain 1	V _{O(off)}	$V_{O(off)} = OUT_1 - OUT_2 $	_	0.3	1.5	V
	Gain 2			_	0.1	1.0	
Output Common Mode Voltage		Vo(cm)		2.4	2.9	3.4	V
Output Voltage Swing		V _{OP-P}	Single-ended	3.0	4.0	_	V _{P-P}
Output Sink Current		İsink		2.5	3.6	_	mA
Power Supply Current		Icc			13	20	mA

Notes 1. Gain select pins G_{1A} and G_{1B} are connected.

2. All gain select pins are opened.

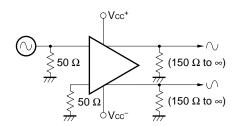
TEST CIRCUIT



Remark Definition and test circuit of each characteristic should be referred to application note 'Usage of μ PC1663 (Document No. G12290E)'.

NOTES ON CORRECT USE

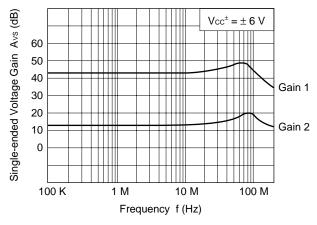
- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as wide as possible to minimize ground impedance (to prevent undesired oscillation).
- (3) The bypass capacitor should be attached to Vcc line.
- (4) When gain between Gain 1 and Gain 2 is necessary, insert adjustment resistor (0 to 10 k Ω) between G1A and G1B to determine gain value.
- (5) Due to high-frequency characteristics, the physical circuit layout is very critical. Supply voltage line bypass, double-sided printed-circuit board, and wide-area ground line layout are necessary for stable operation. Two signal resistors connected to both inputs and two load resistors connected to both outputs should be balanced for stable operation.



5

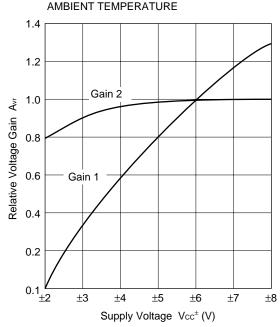
TYPICAL CHARACTERISTICS (Unless otherwise specified T_A = +25 °C)

SINGLE-ENDED VOLTAGE GAIN vs. FREQUENCY

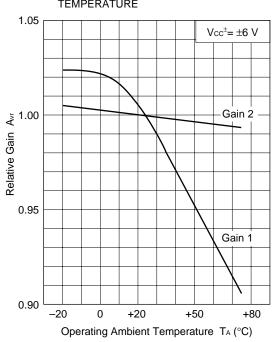


Remark Differential voltage gain is double of single-ended voltage gain.

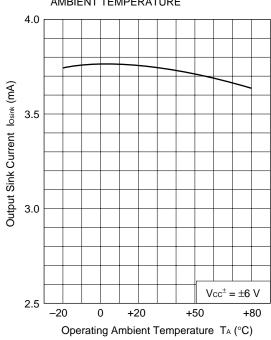
RELATIVE VOLTAGE GAIN vs. OPERATING



RELATIVE GAIN vs. OPERATING AMBIENT TEMPERATURE

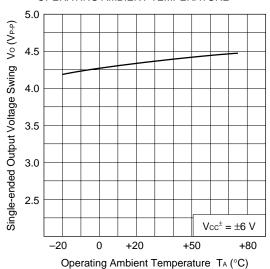


OUTPUT SINK CURRENT vs. OPERATING AMBIENT TEMPERATURE

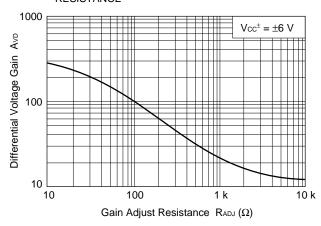


Remark Relative voltage gains are described based on gains 1.00 at $T_A = +25$ °C, $V_{CC}^{\pm} = \pm 6 \text{ V}$

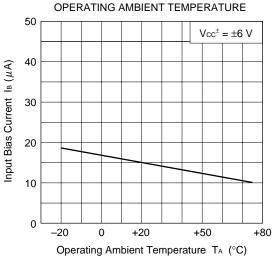
SINGLE-ENDED OUTPUT VOLTAGE SWING vs. OPERATING AMBIENT TEMPERATURE



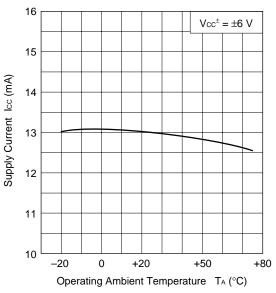
DIFFERENTIAL VOLTAGE GAIN vs. GAIN ADJUST RESISTANCE



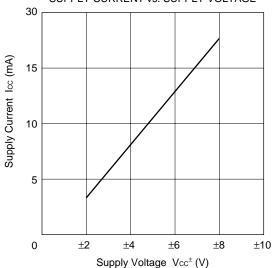
INPUT BIAS CURRENT vs.



SUPPLY CURRENT vs.
OPERATING AMBIENT TEMPERATURE



SUPPLY CURRENT vs. SUPPLY VOLTAGE

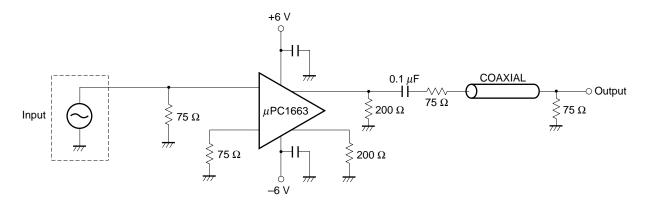




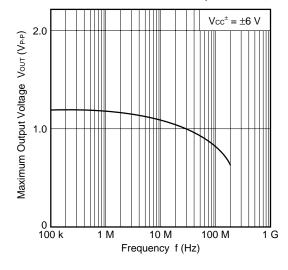
APPLICATION CIRCUIT EXAMPLES

EXAMPLE 1

Video Line Driver Circuit Example



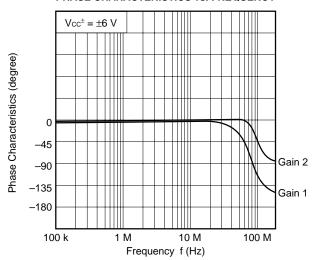
MAXIMUM OUTPUT VOLTAGE vs. FREQUENCY (VIDEO LINE, SINGLE-ENDED)



Remark

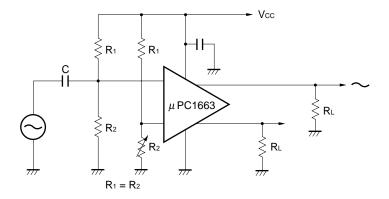
Differential output voltage is double of single-ended output voltage.

PHASE CHARACTERISTICS vs. FREQUENCY



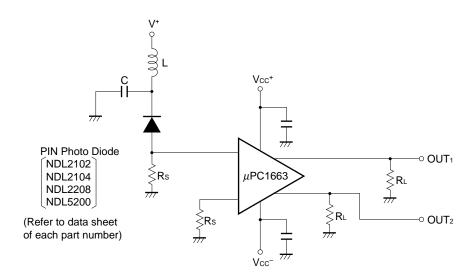
EXAMPLE 2

Vcc single supply application example (Outline)



EXAMPLE 3

Photo signal detector circuit example (Outline)



Caution When signal source impedance for μ PC1663 is critical, FET source follower buffer should be inserted between PIN Photo diode and μ PC1663 input.

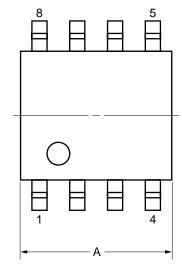
The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

Precautions for design in and detail application circuit examples should be referred to application note 'Usage of μ PC1663 (Document No. G12290E)'.

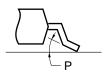
PACKAGE DIMENSIONS

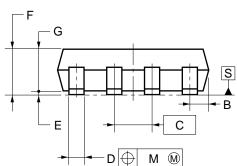
* 8 PIN PLASTIC SOP (225 mil) (Unit: mm)

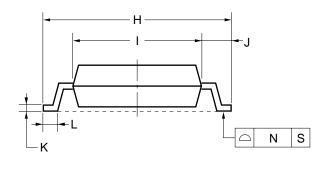
- μPC1663G -



detail of lead end







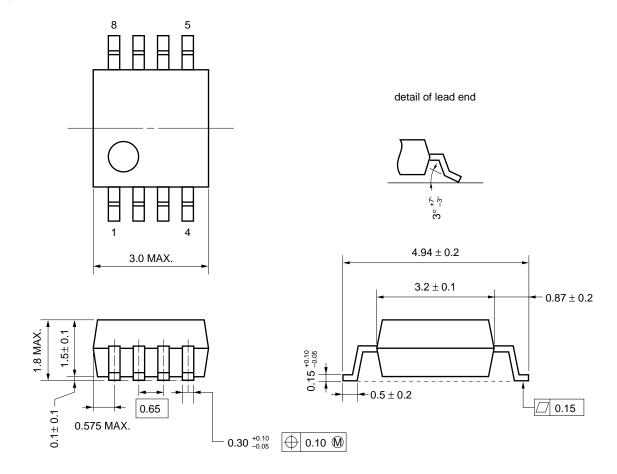
NOTE

Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
Α	5.2±0.2
В	0.85 MAX.
С	1.27 (T.P.)
D	$0.42^{+0.08}_{-0.07}$
E	0.1±0.1
F	1.57±0.2
G	1.49
Н	6.5±0.3
I	4.4±0.15
J	1.1±0.2
K	$0.17^{+0.08}_{-0.07}$
L	0.6±0.2
М	0.12
N	0.10
Р	3°+7°

8 PIN PLASTIC SSOP (175 mil) (Unit: mm)

- μPC1663GV -



11



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your NEC sales representative.

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared Reflow	Package peak temperature: 235 °C or below Time: 30 seconds or less (at 210 °C) Count: 3, Exposure limit: NoneNote	IR35-00-3
VPS	Package peak temperature: 215 °C or below Time: 40 seconds or less (at 200 °C) Count: 3, Exposure limit: NoneNote	VP15-00-3
Wave Soldering	Soldering bath temperature: 260 °C or below Time: 10 seconds or less Count: 1, Exposure limit: None ^{Note}	WS60-00-1
Partial Heating	Pin temperature: 300 °C Time: 3 seconds or less (per side of device) Exposure limit: None ^{Note}	_

Note After opening the dry pack, keep it in a place below 25 °C and 65 % RH for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

For details of recommended soldering conditions for surface mounting, refer to information document SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E)

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 - Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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